

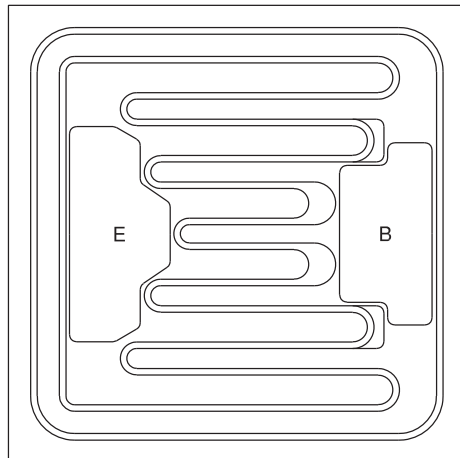
**PROCESS CP305**  
**Small Signal Transistor**  
NPN - High Current Transistor Chip



**PROCESS DETAILS**

Process	EPITAXIAL PLANAR
Die Size	31 x 31 MILS
Die Thickness	9.0 MILS
Base Bonding Pad Area	5.9 x 11.8 MILS
Emitter Bonding Pad Area	6.5 x 13.8 MILS
Top Side Metalization	Al - 30,000Å
Back Side Metalization	Au - 18,000Å

**GEOMETRY**



BACKSIDE COLLECTOR R2

**GROSS DIE PER 4 INCH WAFER**

11,212

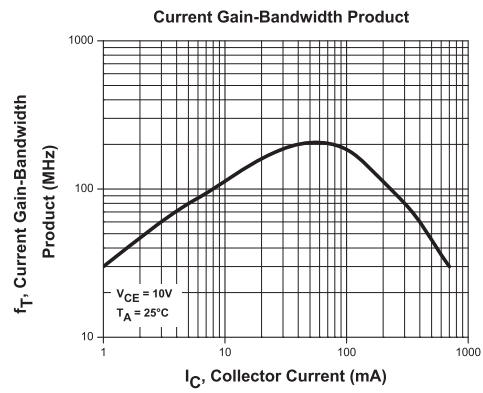
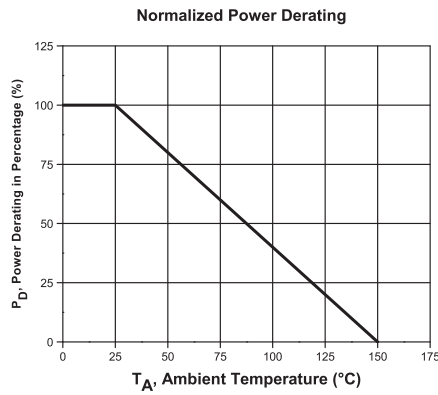
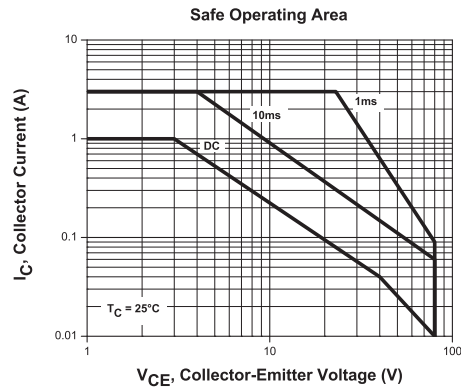
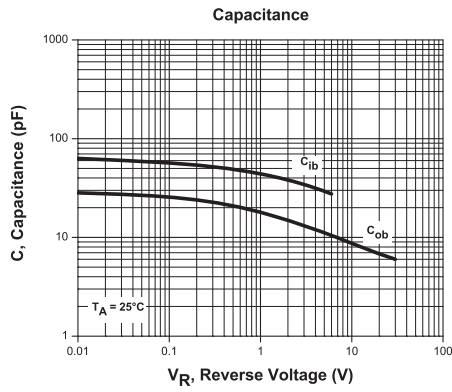
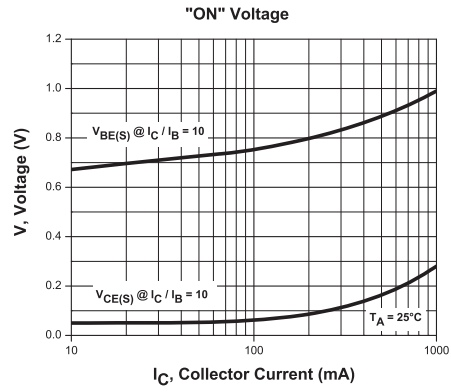
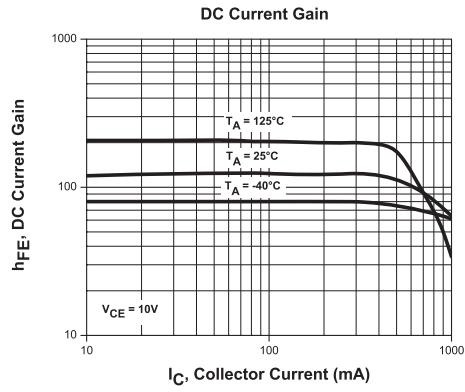
**PRINCIPAL DEVICE TYPES**

2N3019  
CMPT3019  
CXT3019  
CZT3019

R3 (22-March 2010)

# PROCESS CP305

## Typical Electrical Characteristics



R3 (22-March 2010)

## OUTSTANDING SUPPORT AND SUPERIOR SERVICES



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### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

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### DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

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### CONTACT US

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